

INA233EVM Evaluation Board and Software Tutorial

This user's guide describes the characteristics, operation, and use of the INA233EVM evaluation board. It discusses how to set up and configure the software and hardware, and reviews various aspects of the program operation. Throughout this document, the terms *evaluation board*, *evaluation module*, and *EVM* are synonymous with the INA233EVM. This user's guide also includes information regarding operating procedures and input/output connections, an electrical schematic, printed circuit board (PCB) layout drawings, and a parts list for the EVM.

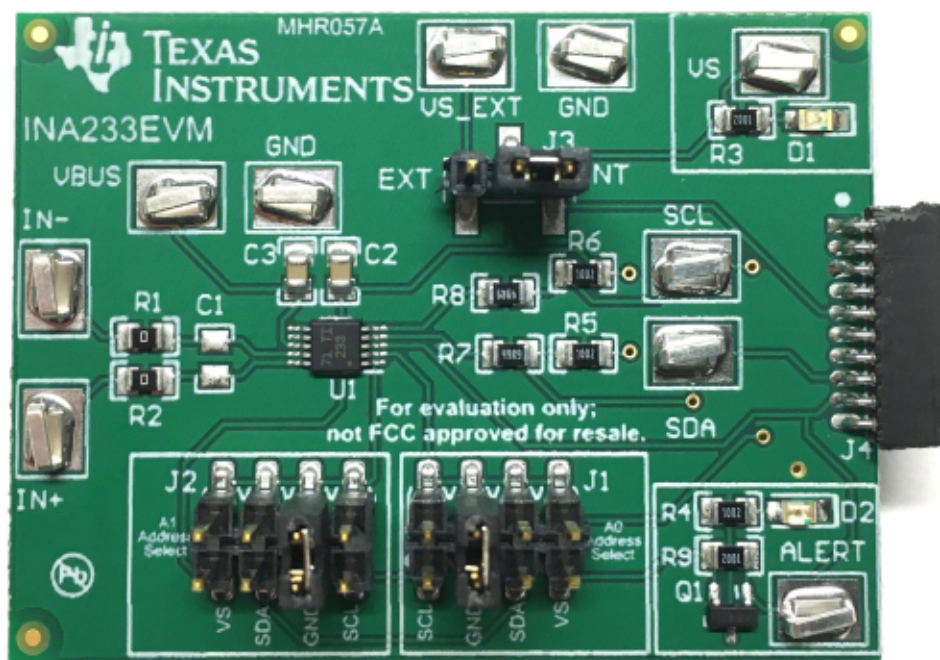


Figure 1. INA233EVM Evaluation Module

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1 Overview

The [INA233](#) is a current shunt and power monitor with an I2C/SMBus/PMBus-compatible interface. The device monitors and reports values for current, power, and voltage. The integrated power accumulator can be used for energy or average power calculations. Programmable calibration value, conversion times, and averaging, combined with an internal multiplier, enable direct readouts of current in amperes and power in watts. The INA233EVM is a platform for evaluating the performance of the INA233 under various signal, shunt, and supply conditions.

This document gives a general overview of the INA233EVM, and provides a general description of the features and functions to be considered while using this evaluation module.

1.1 INA233EVM Kit Contents

[Table 1](#) summarizes the contents of the INA233EVM kit. [Figure 2](#) shows all of the included hardware. Contact the [Texas Instruments Product Information Center](#) nearest you if any component is missing. TI also highly recommends that you also check the [INA233 product folder](#) on the TI web site at www.ti.com to verify that you have the latest versions of the related software.

Table 1. INA233EVM Kit Contents

Item	Quantity
INA233EVM PCB Test Board	1
SM-USB-DIG Platform PCB	1
USB Extender Cable	1



Figure 2. Hardware Included with INA233EVM Kit

1.2 Related Documentation from Texas Instruments

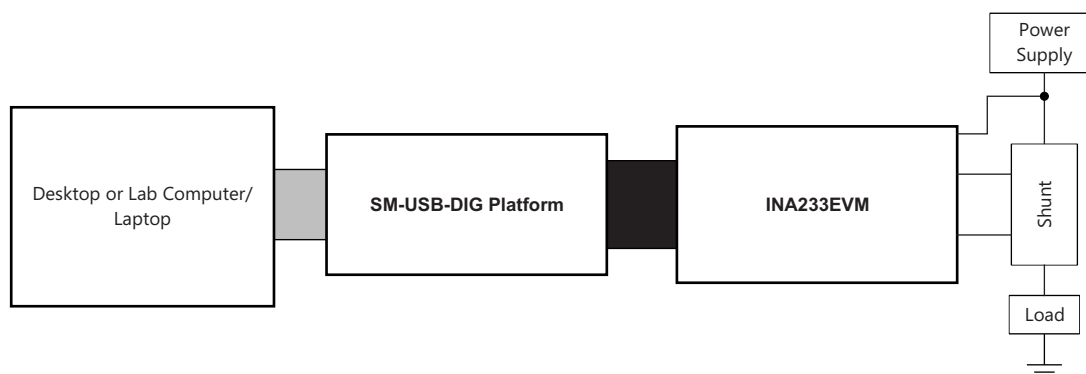
The following documents provide information regarding Texas Instruments integrated circuits used in the assembly of the INA233EVM. This user's guide is available from the TI web site under literature number [SBOU187](#). Any letter appended to the literature number corresponds to the document revision that is current at the time of the writing of this document. Newer revisions may be available from the [TI web site](#), or call the Texas Instruments' Literature Response Center at (800) 477-8924 or the Product Information Center at (972) 644-5580. When ordering, identify the document by both title and literature number.

Table 2. Related Documentation

DOCUMENT	LITERATURE NUMBER
INA233 Product Data Sheet	SBOS790
SM-USB-DIG Platform User Guide	SBOU098

2 INA233EVM Hardware

[Figure 3](#) shows the overall system setup for the INA233EVM. The PC runs software that communicates with the SM-USB-DIG Platform. The SM-USB-DIG Platform generates the analog and digital signals used to communicate with the INA233 test board. Connectors on the INA233EVM test board allow the user to connect to the system under test conditions and monitor the power, current, and voltage.

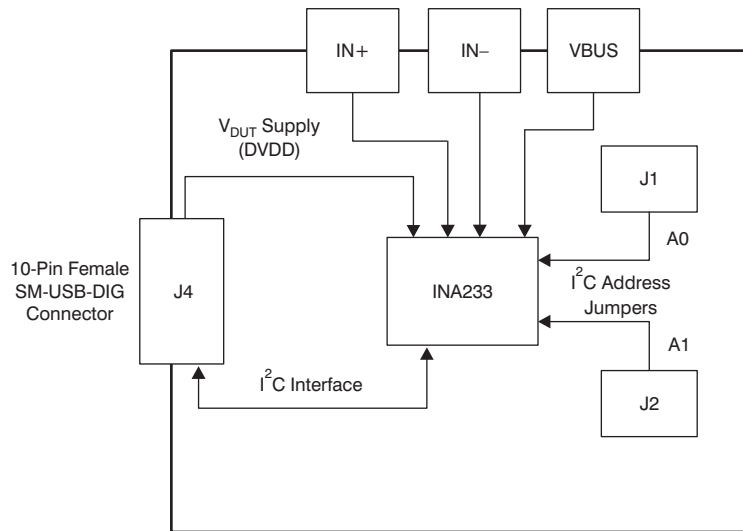


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Figure 3. INA233EVM Hardware Setup

2.1 Theory of Operation for INA233 Hardware

Figure 4 depicts a block diagram of the INA233EVM PCB highlighting the power supplies, analog inputs, and digital I/O signals.



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Figure 4. INA233EVM Board Block Diagram

2.2 Signal Definitions of H1 (10-Pin Male Connector Socket)

Table 3 lists the pinout for the 10-pin connector socket used to communicate between the INA233EVM and the SM-USB-DIG. It should be noted that the INA233EVM only uses the necessary I²C communication lines (pins 1 and 3) and the VS and GND pins (pin 6 and pin 8) to issue commands to the INA233 chip.

Table 3. Signal Definition of J4 on INA233EVM Board

Pin on J4	Signal	Description
1	I2C_SCL	I ² C Clock Signal (SCL)
2	CTRL/MEAS4	GPIO: Control Output or Measure Input
3	I2C_SDA1	I ² C Data Signal (SDA)
4	CTRL/MEAS5	GPIO: Control Output or Measure Input
5	SPI_DOUT1	SPI Data Output (MOSI)
6	V _{DUT}	Switchable DUT Power Supply: +3.3 V, +5 V, Hi-Z (Disconnected) ⁽¹⁾
7	SPI_CLK	SPI Clock Signal (SCLK)
8	GND	Power Return (GND)
9	SPI_CS1	SPI Chip Select Signal ($\overline{CS}$)
10	SPI_DIN1	SPI Data Input (MISO)

⁽¹⁾ When V_{DUT} is Hi-Z, all digital I/O are Hi-Z as well.

2.2.1 SM-USB-DIG Platform Description

Figure 5 shows the block diagram for the SM-USB-DIG Platform. This platform is a general-purpose data acquisition system that is used on several different Texas Instruments evaluation modules. The details of its operation are included in a separate document, [SBOU098](#) (available for download at [www.ti.com](#)). The block diagram shown in Figure 5 gives a brief overview of the platform. The primary control device on the SM-USB-DIG Platform is the [TUSB3210](#). The TUSB3210 is an 8052 microcontroller that has an onboard USB interface. The microcontroller receives information from the host computer that it interprets into power, I²C, SPI, and other digital I/O patterns. During the digital I/O transaction, the microcontroller reads the response of any device connected to the I/O interface. The response from the device is sent back to the PC where it is interpreted by the host computer.

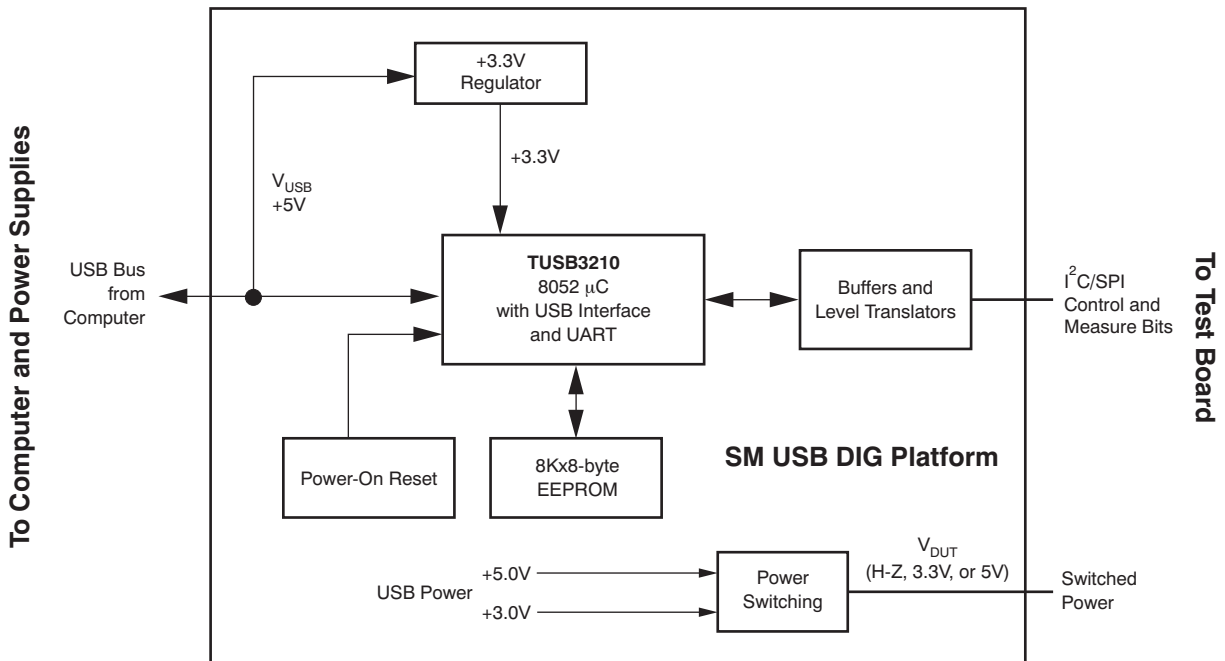


Figure 5. SM-USB-DIG Platform Block Diagram

3 INA233EVM Hardware Setup

Setting up the INA233EVM involves the following sequence of operations:

- Perform a one-time GUI software installation
- Configure the EVM jumpers
- Connect the hardware
- Power-up the EVM and input source

3.1 Electrostatic Discharge Warning

CAUTION

Many of the components on the INA233EVM are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling precautions when unpacking and handling the EVM, including the use of a grounded wrist strap at an approved ESD workstation.

3.2 One-Time INA233EVM GUI Software Setup

This section discusses how to install the INA233EVM software.

3.2.1 Hardware Requirements

The INA233EVM software must be installed on a computer running Windows XP or later. Windows 7 is the recommended operating system.

3.2.2 Software Installation

Make sure the hardware is not connected to the computer. Download the INA233EVM GUI from the INA233 Tools & Software folder. Extract the contents of the downloaded .zip file and run Setup_INA233EVM.exe. Follow the on-screen instructions provided in [Figure 6](#) to complete the software installation.

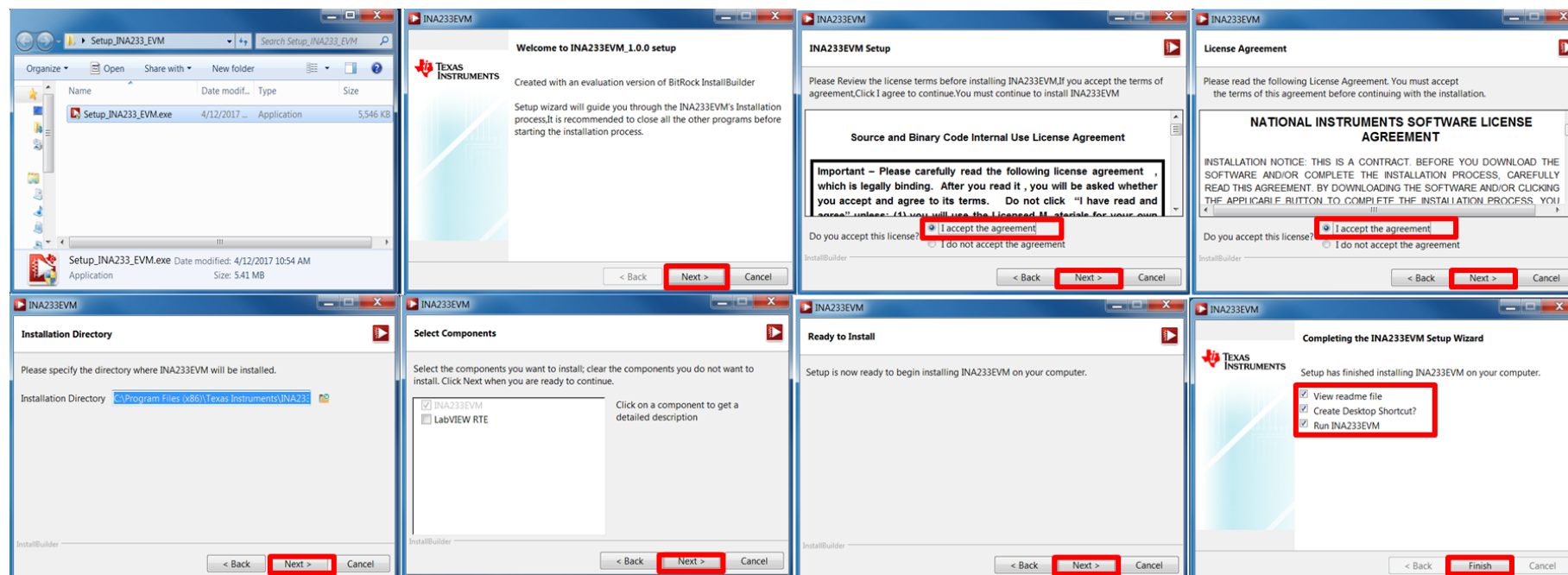


Figure 6. INA233EVM Software Installation

3.3 Configuration of INA233EVM Jumper Settings

Figure 7 shows the default jumper configuration for the INA233EVM. In general, the jumper settings of the SM-USB-DIG Platform do not need to be changed. You may want to change some of the jumpers on the INA233EVM board to match your specific configuration. For example, you may wish to set a specific I²C address by configuring J1 and J2.

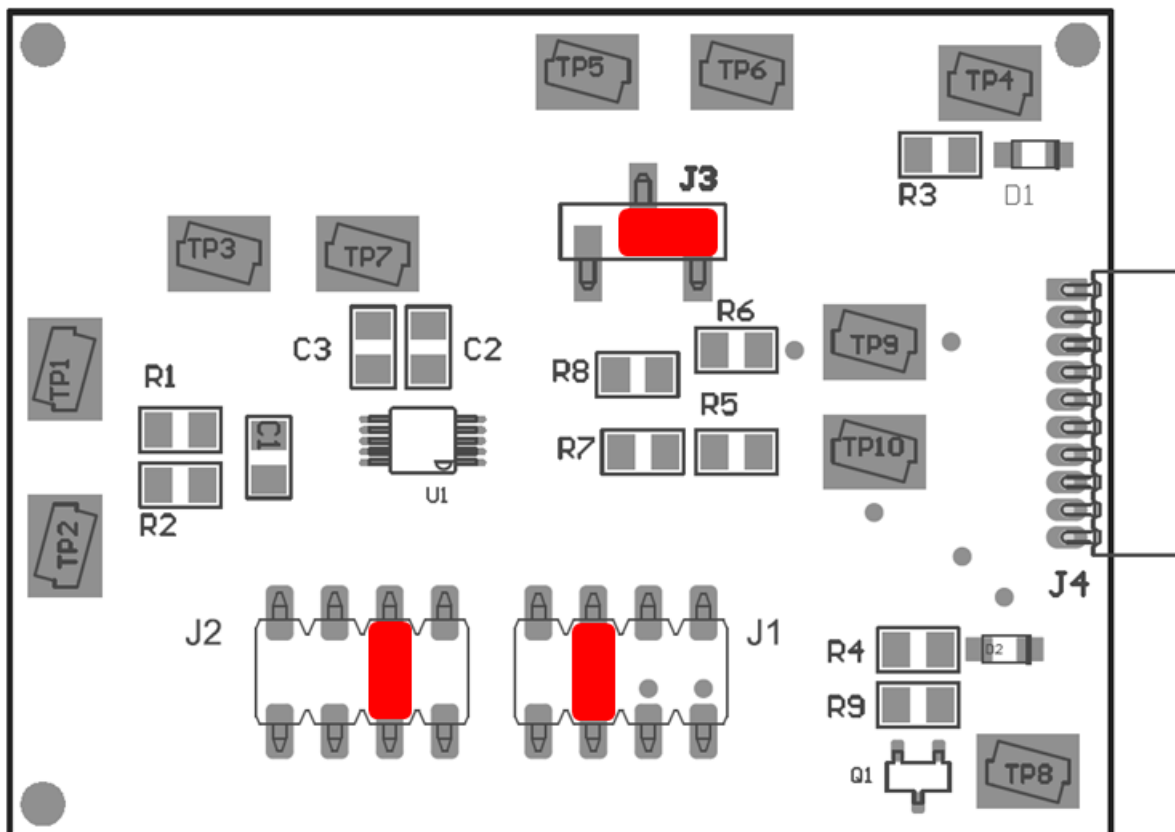


Figure 7. INA233EVM Default Jumper Settings

Typically, jumper 3 (J3) on the INA233EVM is always set to the INT position. When set to the INT position, the SM-USB-DIG Platform provides the supply for the INA233. When this jumper is set to the EXT position, an external supply voltage can be connected to test point VS_EXT to provide the supply for the INA233.

Jumper 1 (J1) and jumper 2 (J2) control the I²C address pins for the INA233. These jumpers can set the address for A0 and A1 to either supply, ground, SCL, or SDA. Make sure to only connect one jumper at a time for each address control. Failure to properly connect jumpers can cause shorts or interruptions in the communication lines. For more information on the INA233 addressing, refer to the [INA233 product data sheet](#).

Table 4 summarizes the function of the INA233 Test Board jumpers. For most applications, all jumpers should be left in the respective default configurations.

Table 4. INA233EVM Test Board Jumper Functions

Jumper	Default	Purpose
J3	INT	This jumper selects whether the V _S pin on the INA233 is connected to the V _{DUT} signal generated from the SM-USB-DIG Platform or whether the digital supply pin is connected to test point VS_EXT, allowing for an external supply to power the device. The default INT position connects the V _S pin to the V _{DUT} control signal.
J1	GND	This jumper selects the I ² C A0 address selection for A0.
J2	GND	This jumper selects the I ² C A1 address selection for A1.

3.4 Connecting the Hardware

To set up the INA233EVM and connect the two PCBs of the EVM together (that is, the INA233 test board and SM-USB-DIG Platform board), gently slide the male and female ends of the 10-pin connectors together. Make sure that the two connectors are completely pushed together; loose connections may cause intermittent operation. [Figure 8](#) show the proper orientation.

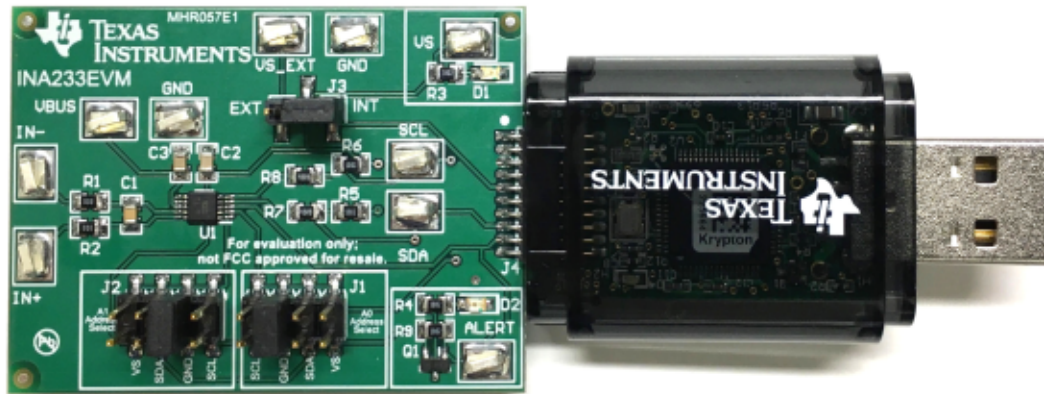


Figure 8. Connecting the INA233 Test Board and SM-USB-DIG Platform Board to the Computer

Lastly, connect the SM-USB-DIG to the computer, using the included USB extender cable. At this point the SM-USB-DIG powers on, but the EVM does not as shown in [Figure 9](#). The power supply to the EVM must be enabled from the GUI.



Figure 9. Connecting the INA233 Test Board and SM-USB-DIG Platform board

3.4.1 System Power-Up

Launch the INA233EVM GUI software. By default the Power button on the GUI is enabled so the VS LED on the EVM (D1) immediately lights up, indicating that the EVM PCB is receiving power, as shown [Figure 10](#)



Figure 10. INA233 Power-Up using SM_USB DIG and INA233EVM GUI Software

The INA233EVM software allows users to customize the board level voltage, regulated by the SM-USB DIG. By selecting either 3.3 V or 5 V, the user can designate which voltage the device should operate at. The supply voltage (VDUT) is set to 3.3 V by default, but if necessary, the 5-V option can be selected, as shown in [Figure 11](#).

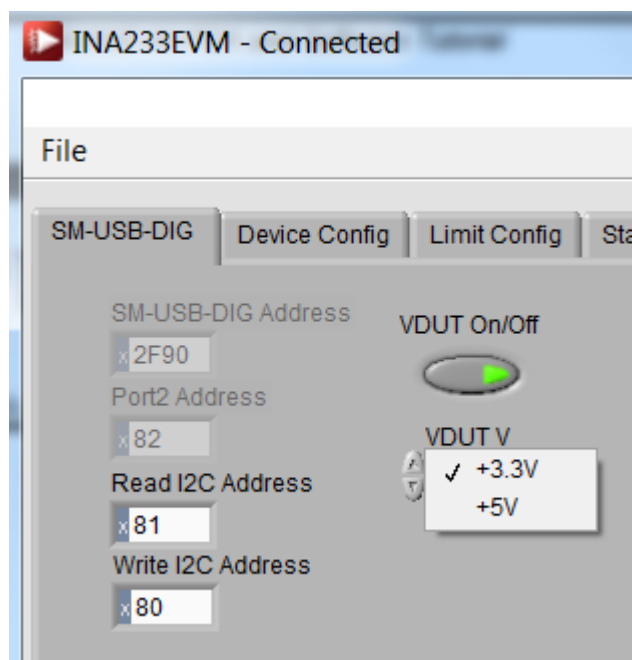


Figure 11. VDUT Voltage Selection in INA233EVM GUI

3.5 INA233EVM Features

This section describes some of the hardware features present on the INA233EVM test board.

3.5.1 J3: I²C VS Control Setting

Jumper J3 selects what the INA233 supply pin is connected to. If J3 is set to the INT position, the VS pin is connected to the switchable V_{DUT} signal generated from the SM-USB-DIG Platform. This voltage can be set to either 3.3 V or 5 V, depending on how it is configured in the software. While J2 is set in the INT position, the VS Power button in the INA233EVM software is able to control whether the V_{DUT} supply voltage is turned on or off.

When J2 is set in the EXT position, an external supply connected to test point VS_EXT can be used to provide the supply voltage for the INA233.

3.5.2 J1: I²C Address Hardware Setting (A0)

Jumper J1 is used to set the hardware setting for the A0 I²C address pin on the INA233. Using J1, the A0 address can be set to VS, GND, SCL or SDA. See [Section 4.2.1](#) on how to configure the INA233EVM software to match the J1 hardware setting.

3.5.3 J2: I²C Address Hardware Setting (A1)

Jumper J2 is used to set the hardware setting for the A1 I²C address pin on the INA233. Using J2, the A1 address can be set to VS, GND, SCL or SDA. See [Section 4.2.1](#) on how to configure the INA233EVM software to match the J2 hardware setting.

3.5.4 External I²C Lines and Test points SCL and SDA

The I²C communication lines on the INA233EVM are tied to two sources: the internal I²C communication lines from the SM-USB-DIG and test points SCL and SDA. If the user wants to add external signals separate from the SM-USB-DIG, simply disconnect the SM-USB-DIG from the INA233EVM board and hook up the necessary SDA, SCL, and GND lines. Also, remember to apply an external supply to the lines that is compatible with the I²C communication device being used.

NOTE: Failure to disconnect the SM-USB-DIG while using external I²C communication can cause damage to the SM-USB-DIG or any external communication devices that are connected.

3.5.5 IN+/IN- Input filter (R1, R2, and C1)

The INA233EVM has an optional input filter to remove high-frequency noise from the inputs IN+ and IN-. This filter is typically unpopulated. The default values for R1 and R2 are 0-Ω resistors.

3.5.6 Shunt Monitor Configuration

The INA233 is generally used in either a high-side or low-side shunt configuration, as shown in [Figure 12](#). Depending on the user's needs, either of these configurations may be used without making any changes to the INA233EVM board or software. The INA233EVM have VBUS, GND, IN+ and IN- test points. Use these test points to apply external voltage sources depending the configuration selected.

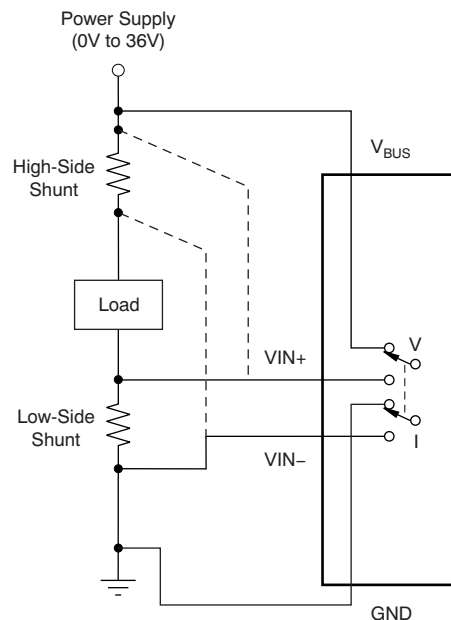


Figure 12. INA233 Shunt Configurations

4 INA233EVM Software Overview

This section discusses how to use the INA233EVM software. Software operation involves a two-step process: configuration of the INA233 settings, and operation of the tool.

4.1 Starting the INA233EVM Software

The INA233 software can be operated through the Windows *Start* menu. From Start, select *All Programs*; then select the *INA233EVM* program.

Figure 13 illustrates how the software should appear if the INA233EVM is functioning properly. The Status Bar should read "VDUT On" and the Hardware Connected bar should be on.

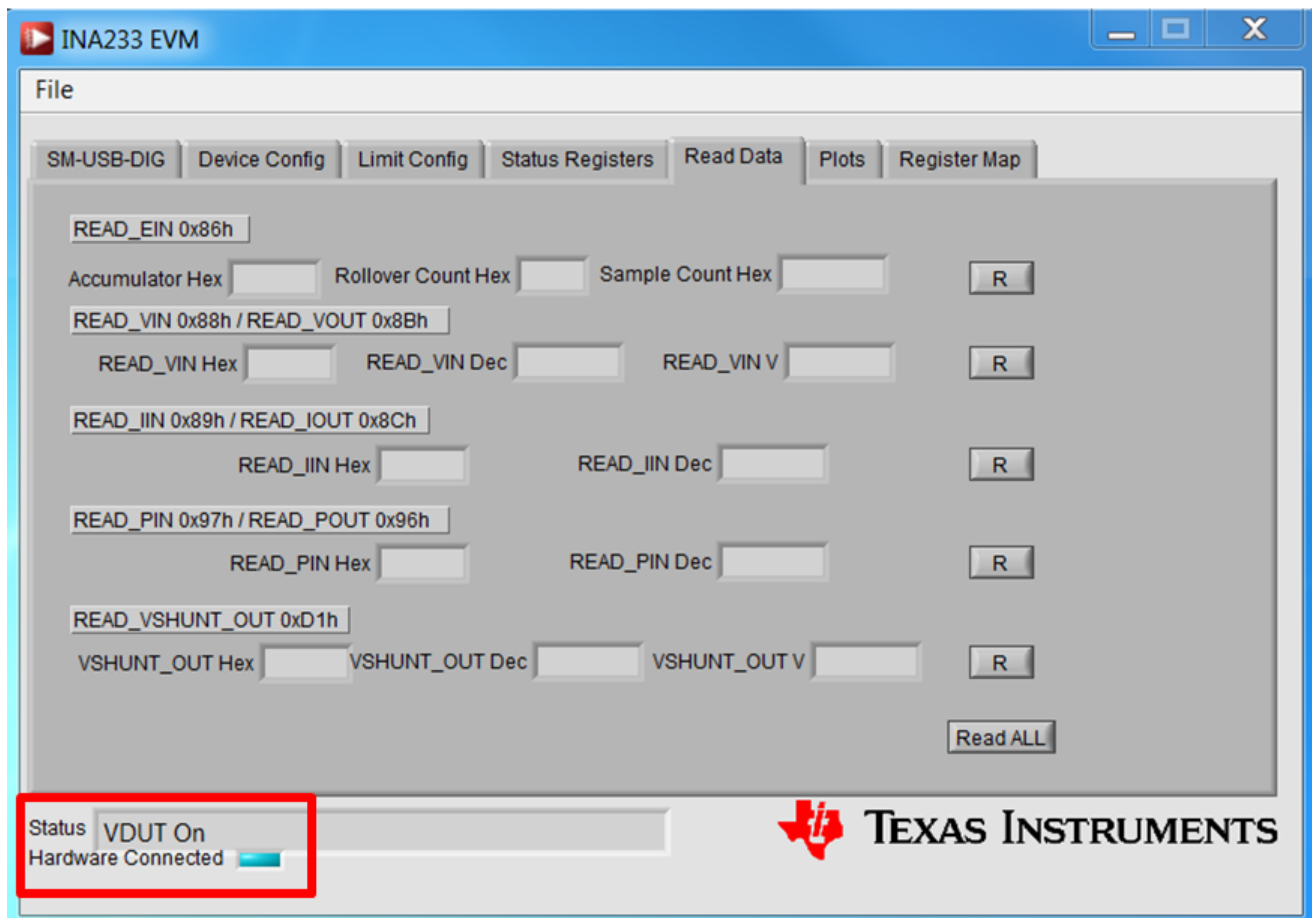


Figure 13. INA233EVM Software Interface

Figure 14 shows how the Software Interface will look if the computer cannot communicate with the EVM. The status bar will read "Check SM-USB-DIG-Connection" and the Hardware Connected light will be off. If you receive this error, first check to see that the USB cable is properly connected on both ends. This error can also occur if you connect the USB cable before the SM-USB-DIG Platform power source. Another possible source for this error is a problem with your PC USB Human Interface Device driver. Make sure that the device is recognized when the USB cable is plugged in; recognition is indicated by a Windows-generated confirmation sound. After verifying all connections are correct, press Re-Initialize. The software interface should look now as Figure 13

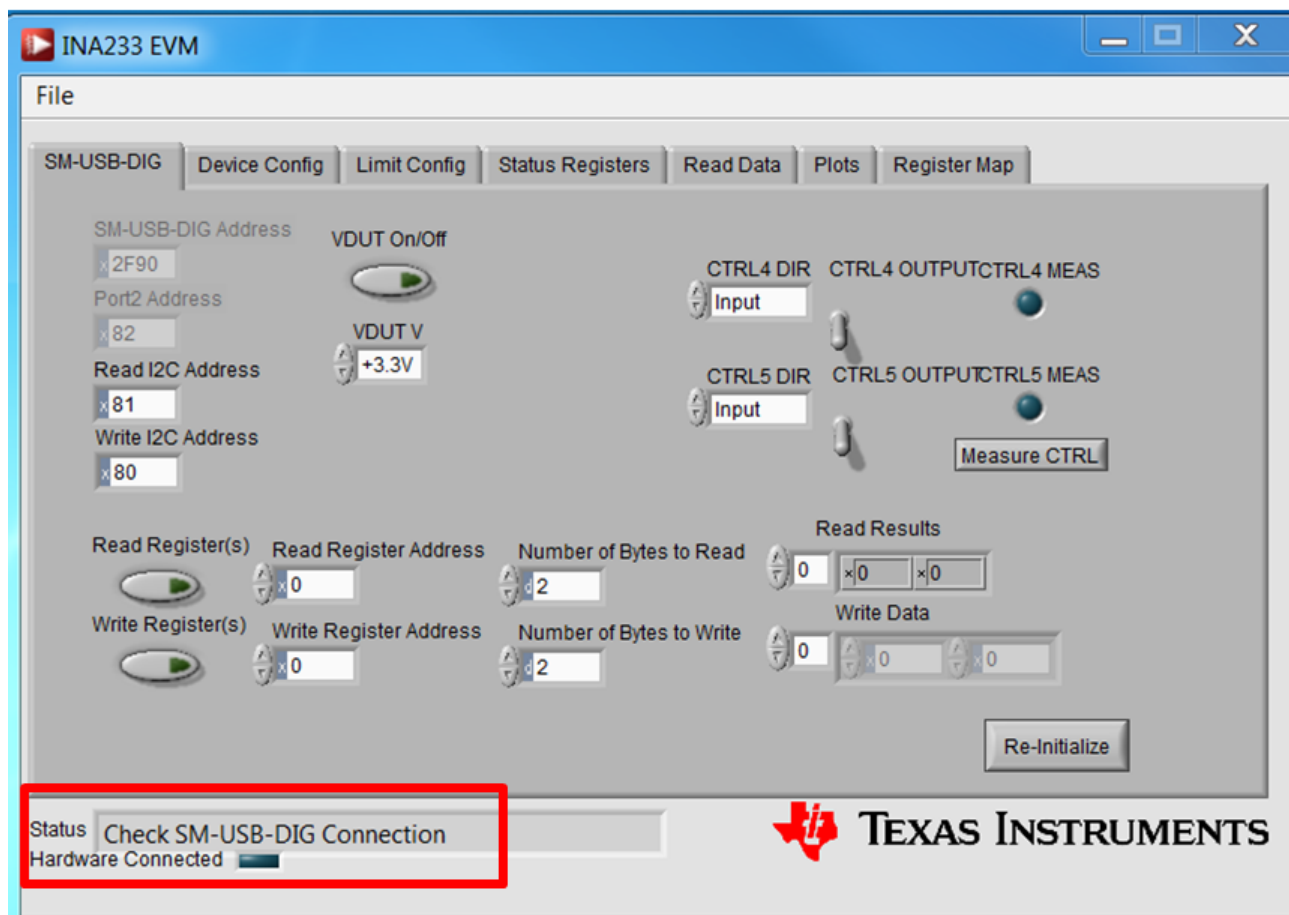


Figure 14. INA233EVM Software: Communication Error with the SM-USB-DIG Platform

4.2 Configuring the INA233EVM Software

The INA233EVM software first requires a series of setup processes to configure the device and ensure that it works properly.

- Step 1. Set I²C Address on the SM-USB-DIG Tab
- Step 2. Set Configuration Register on the Device Config Tab
 - Set Averaging Mode
 - Set Conversion Times
 - Set Operating Modes
- Step 3. Set Calibration Register on the Device Config Tab
- Step 4. Set the MFR_DEVICE_CONFIG Register on the Device Config Tab
- Step 5. Set the Warning Limits Registers on the Limit Config Tab

4.2.1 I²C Address Selection

The INA233 device has a flexible I²C address configuration that allows for multiple devices to be on the same I²C lines. By moving the A0 and A1 addresses on jumpers J1 and J2 to either GND, VS, SDA, or SCL, the INA233 can be changed to a total of 16 I²C addresses as shown in [Table 5](#).

Table 5. INA233 I²C Address Configuration

A1	A0	Slave Address	Corresponding I2C Address in the GUI
GND	GND	1000000	Read: x81 Write: x80
GND	VS	1000001	Read: x83 Write: x82
GND	SDA	1000010	Read: x85 Write: x84
GND	SCL	1000011	Read: x87 Write: x86
VS	GND	1000100	Read: x89 Write: x88
VS	VS	1000101	Read: x8B Write: x8A
VS	SDA	1000110	Read: x8D Write: x8C
VS	SCL	1000111	Read: x8F Write: x8E
SDA	GND	1001000	Read: x91 Write: x90
SDA	VS	1001001	Read: x93 Write: x92
SDA	SDA	1001010	Read: x95 Write: x94
SDA	SCL	1001011	Read: x97 Write: x96
SCL	GND	1001100	Read: x99 Write: x98
SCL	VS	1001101	Read: x9B Write: x9A
SCL	SDA	1001110	Read: x9D Write: x9C
SCL	SCL	1001111	Read: x9F Write: x9E

[Figure 15](#) illustrates how to configure the I²C addresses. To configure the I2C address in the GUI navigate to the SM-USB-DIG tab. Click on the Read I2C Address and Write I2C Address to input the I2C address configured on the INA233EVM hardware. Refer to [Table 5](#) to make sure you assign the correct values.

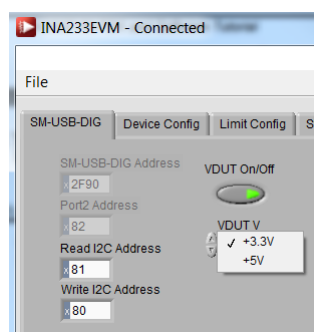


Figure 15. Setting the I²C Address

4.2.2 Set the Configuration Register (MFR_ADC_CONFIG)

The Configuration Register settings control the operating modes for the device. This register controls the conversion time settings for both the shunt and bus voltage measurements as well as the averaging mode used. The operating mode that controls what signals are selected to be measured is also programmed in the Configuration Register. The Device Configuration tab of the INA233EVM GUI allows the user to set the averaging mode (AVG[2:0]), Vbus conversion time (VBUSCT[2:0]), Vshunt conversion time (VSHCT[2:0]) and operating mode (MODE[2:0]).

4.2.2.1 Set Averaging Mode

The Device Configuration tab contains a drop down box for selecting the Averaging Mode, as shown in [Figure 16](#). The averaging mode selected determines the number of samples that are collected and averaged before storing the value of the measurements in the register table.

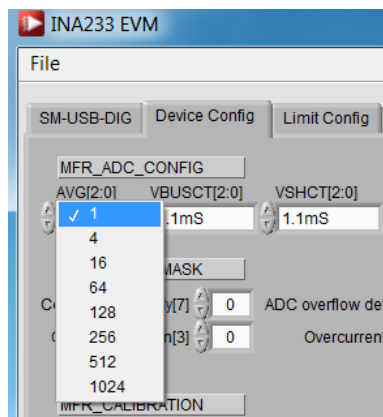


Figure 16. Configuring Averaging Mode

4.2.2.2 Set Conversion Times

Setting the conversion times allows the user to customize the amount of measurement time for conversions. Typically, for the INA233EVM software, the user is not able to notice a visual difference between the conversion times unless a high averaging mode and conversion time are chosen. The Shunt and Bus conversion times can be set as shown in [Figure 17](#).

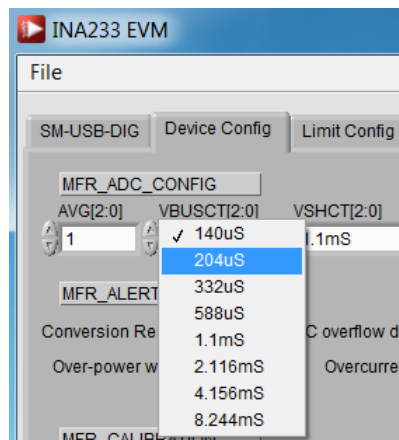


Figure 17. Configuring Conversion Times

4.2.2.3 Set Operating Mode

The Device Configuration tab contains a drop down box for selecting the Operating Mode, as shown in [Figure 18](#). The Operating mode allows the user to restrict the amount of calculations done within the INA233 by changing the conversion to be triggered or continuous, or shutting down the part altogether. The Device Configuration tab of the INA233EVM GUI allows the user to set the averaging mode (AVG[2:0]), Vbus conversion time (VBUSCT[2:0]), Vshunt conversion time (VSHCT[2:0]) and operating mode (MODE[2:0]).

It is important to note that for complete functionality of the INA233, a configuration must be chosen with Shunt and Bus configuration. Failure to choose Shunt and Bus configuration disables a considerable portion of the unit functionality as discussed in the [INA233 data sheet](#).

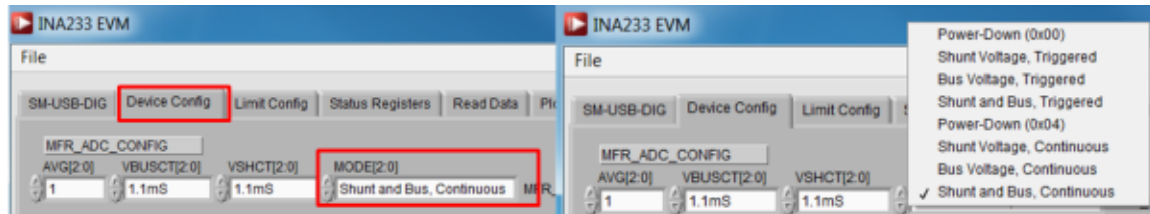


Figure 18. Configuring Operating Mode

4.2.3 Set Calibration Register (MFR_CALIBRATION)

The Calibration Register must then be set correctly for the software to operate properly. The user needs to manually calculate the desired value using [Equation 1](#) and then input that value into the MFR_Calibration box, as shown in [Figure 19](#). After this, the user must press W in order to write into the Calibration Register. If inputs were correct the MFR_CALIBRATION and MFR_CALIBRATION Hex boxes should display the same values after pressing R (Pressing R reads the Calibration Register).

$$\text{Calibration Register} = \frac{0.00512}{\text{Current_LSB} \cdot R_{\text{SHUNT}}} \quad (1)$$

The current LSB is calculated by a recommended range in the INA233 data sheet as shown in [Equation 2](#). It is important to note that the Current LSB and the Calibration Register values are calculated based on the other variable and the R_{SHUNT} value. See the section, *Programming the INA233* in the [product data sheet](#) for more information on setting the Calibration Register value.

$$\frac{\text{Maximum Expected Current}}{2^{15}} \leq \text{Current_LSB} \leq \frac{\text{Maximum Expected Current}}{2^{12}} \quad (2)$$

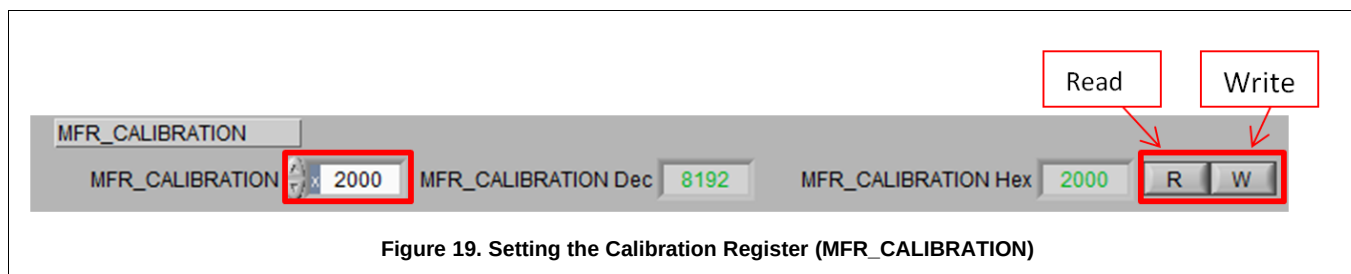


Figure 19. Setting the Calibration Register (MFR_CALIBRATION)

4.2.4 Set the MFR_DEVICE_CONFIG Register

This register configures various behaviors of the device in regards to data communications and alerts. The user is able to write and read these registers in the Device Configuration Tab as shown in [Figure 20](#). Refer to MFR_DEVICE_CONFIG Register section on the datasheet for register details.

Figure 20. Set the MFR_DEVICE_CONFIG Register

4.2.5 Set the MFR_ALERT_MASK

The bits in this register correspond to the bits in the STATUS_MFR_SPECIFIC register. Setting a bit in this register will block the corresponding bit in the STATUS_MFR_SPECIFIC register from having an effect on the ALERT pin. The user is able to write and read these registers in the Device Configuration Tab as shown in [Figure 21](#). Refer to MFR_ALERT_MASK Register table in the datasheet for register bits details.

Figure 21. Set the MFR_ALERT_MASK Register

4.2.6 Set the Warning Limit Registers

The Limit configuration tab allows the user to set the values for the following warning limit registers:

- IOUT_OC_WARN_LIMIT Register
- VIN_OV_WARN_LIMIT Register
- VIN_UV_WARN_LIMIT Register
- POUT_OP_WARN_LIMIT Register

The user is able to write and read these registers in the Device Configuration Tab as shown in [Figure 22](#). Refer to data sheet *Standard PMBus Commands* section for register descriptions.

Figure 22. Set the Warning Limit Registers

4.3 Using the INA233EVM Software

After configuring the INA233EVM software, the rest of the tabs can be evaluated. This section describes the basic operation of the device, and offers guidelines for interpreting the graphic user interface (GUI).

4.3.1 Read Data Tab

Navigate to the Read Data tab, refer to [Figure 23](#). This Tab allows the user to read the following registers:

- READ_EIN (0x86h) : Retrieves the energy reading measurement.
- READ_VIN (0x88h): Retrieves input BUS voltage measurement.
- READ_IIN (0x89h): Retrieves the input current measurement.
- READ_PIN (0x97h): Retrieves the input power measurement.
- READ_VSHUNT_OUT (0xD1h): Retrieves shunt voltage measurement.

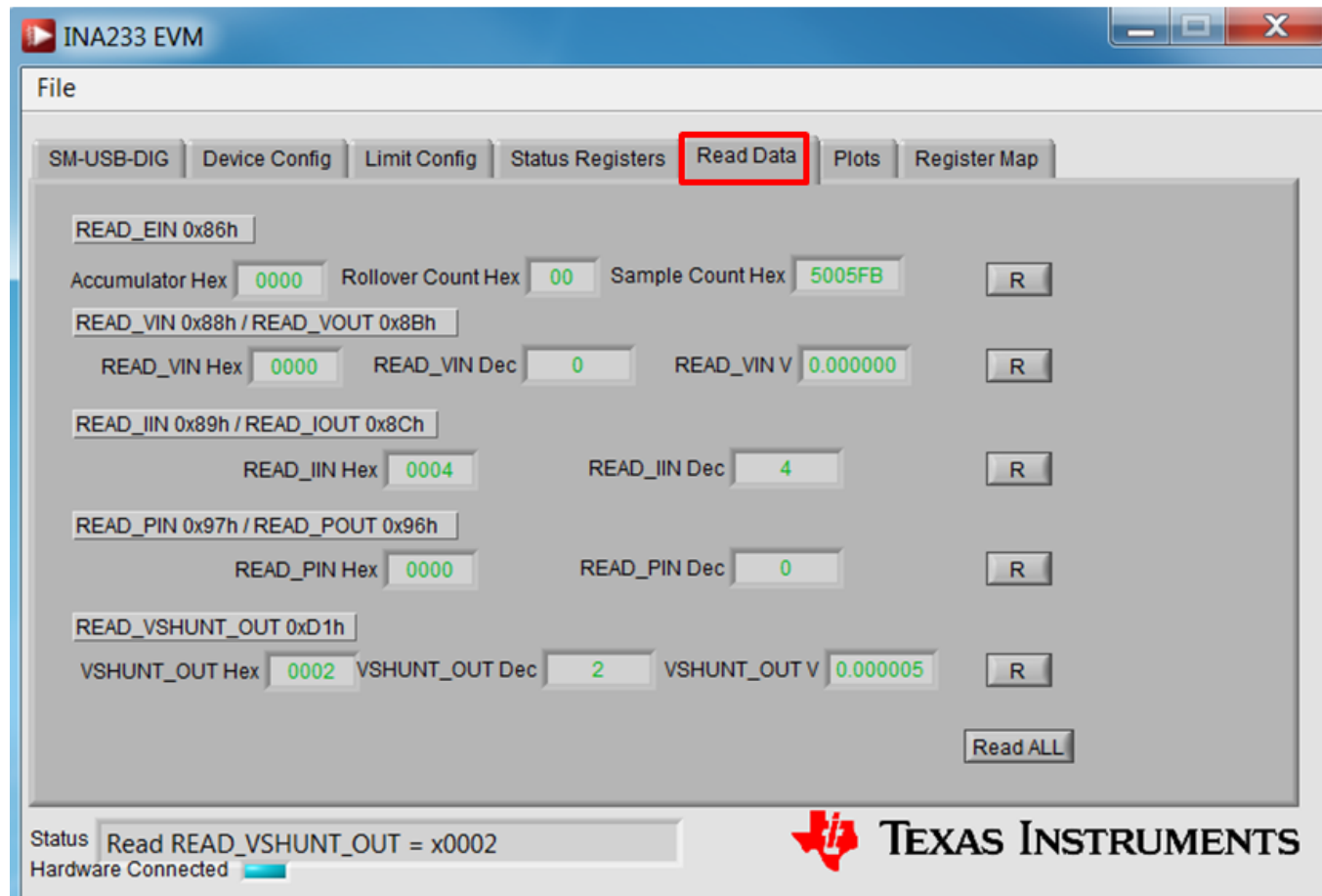


Figure 23. Read Data Tab

4.3.2 Status Register Tab

Navigate to the Status Registers Tab, refer to [Figure 24](#). This Tab allows the user to read the following registers:

- STATUS_BYTE(0x78h) :Retrieves information about the part's operating status.
- STATUS_WORD (0x79h): Retrieves information about the part's operating status.
- STATUS_IOUT (0x7Bh): Retrieves information about output current status.
- STATUS_INPUT (0x7Ch): Retrieves information about input status.
- STATUS_CML (0x7Eh): Retrieves information about communications status.
- STATUS_MFR_SPECIFIC (0x80h): Retrieves information about manufacturer-specific device status.

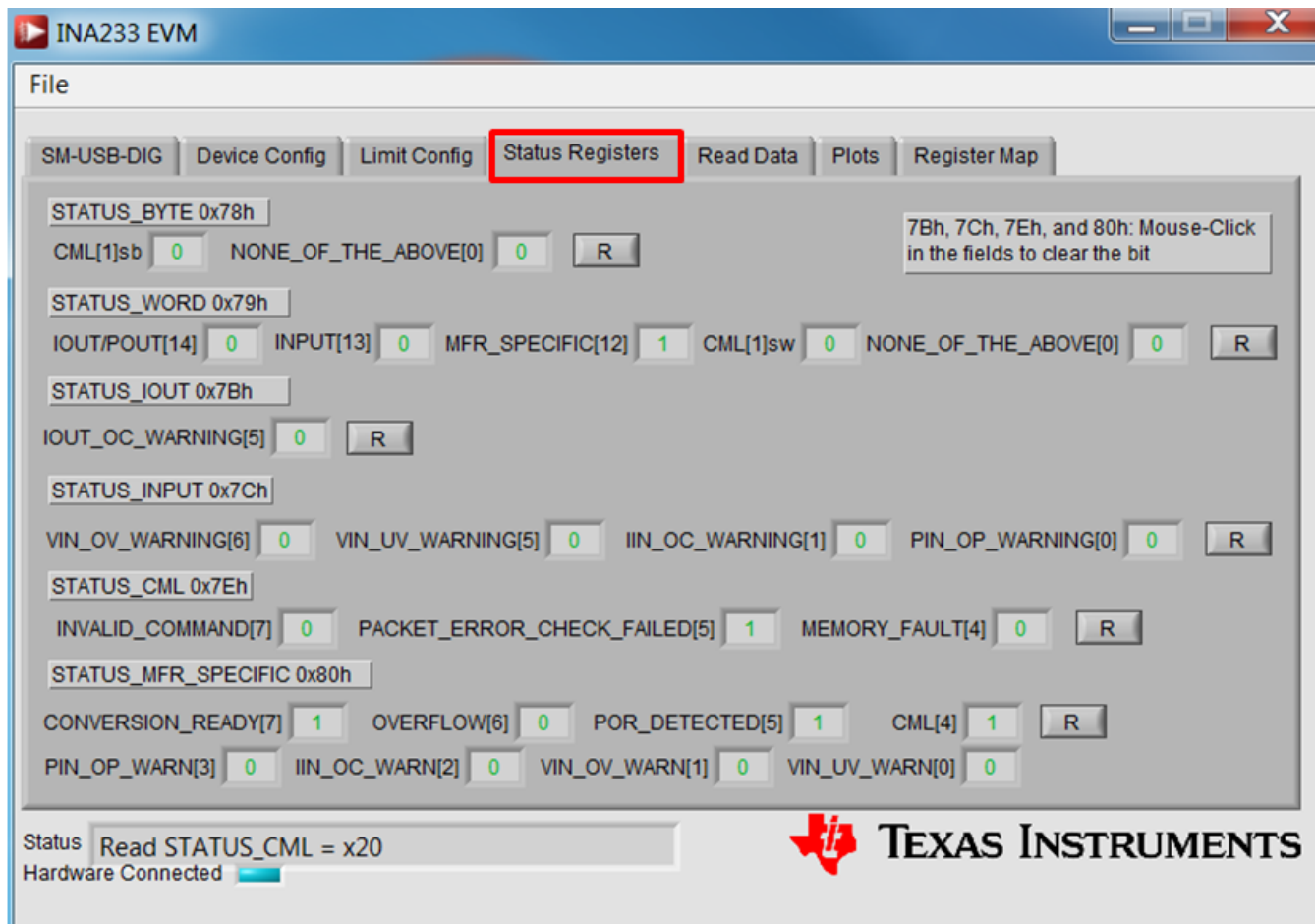


Figure 24. Status Register Tab

4.3.3 Register Map Tab

The Register tab contains information on the individual operation of the INA233 registers as shown in Figure 25.

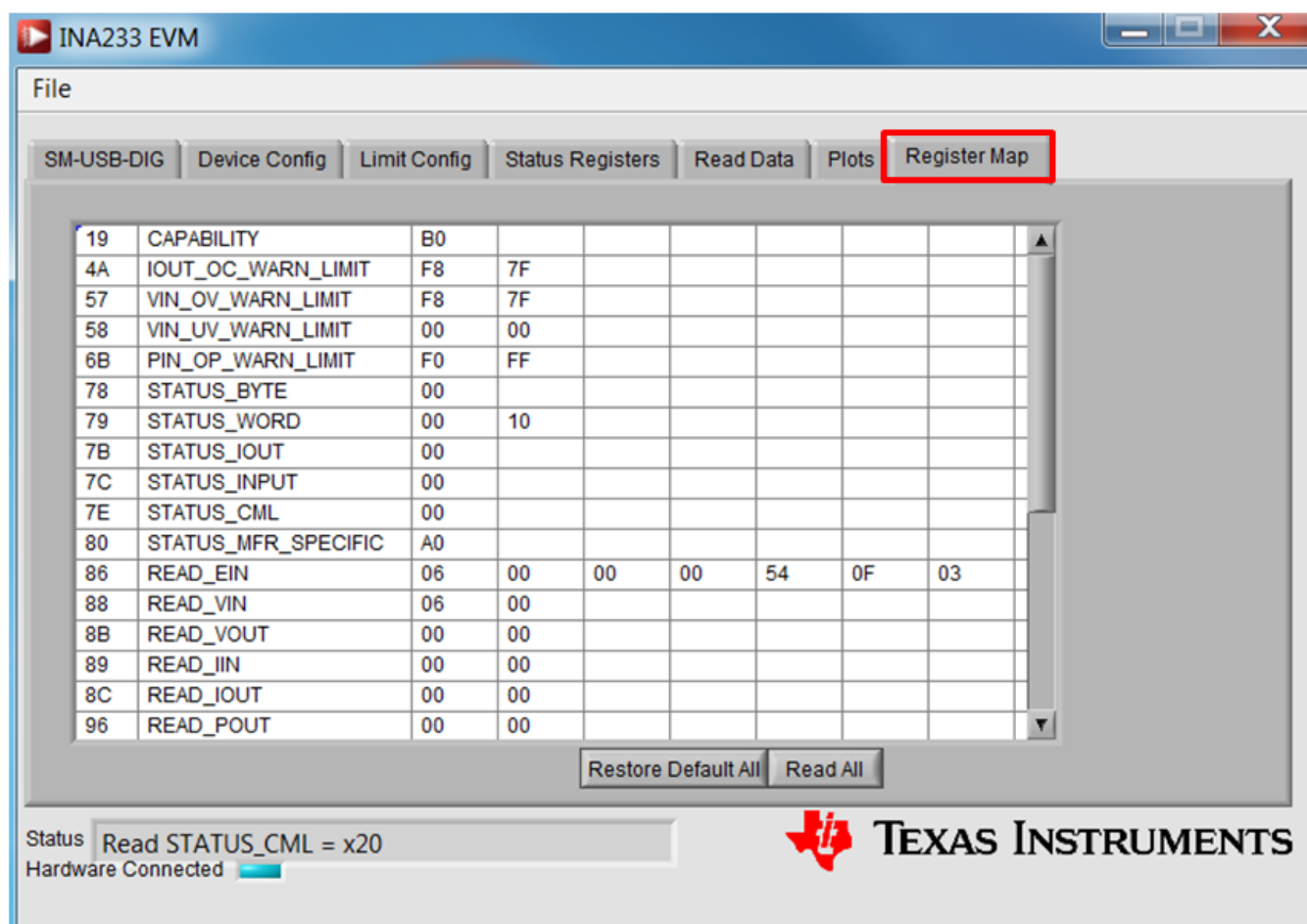


Figure 25. Registers Map Tab

4.3.4 Plots Tab

The Plots tab contains a plot window that shows the progression of data over time on the INA233. All four variables at the bottom of the EVM software (Vshunt (READ_VSHUNT_OUT), Vbus (READ_VIN), Current (READ_IIN) and Power (READ_PIN)) can be plotted using the drop-down box directly below the graph. After the desired plot has been selected, toggle the **Capture Data in Loop** button above the plot to begin polling for data.

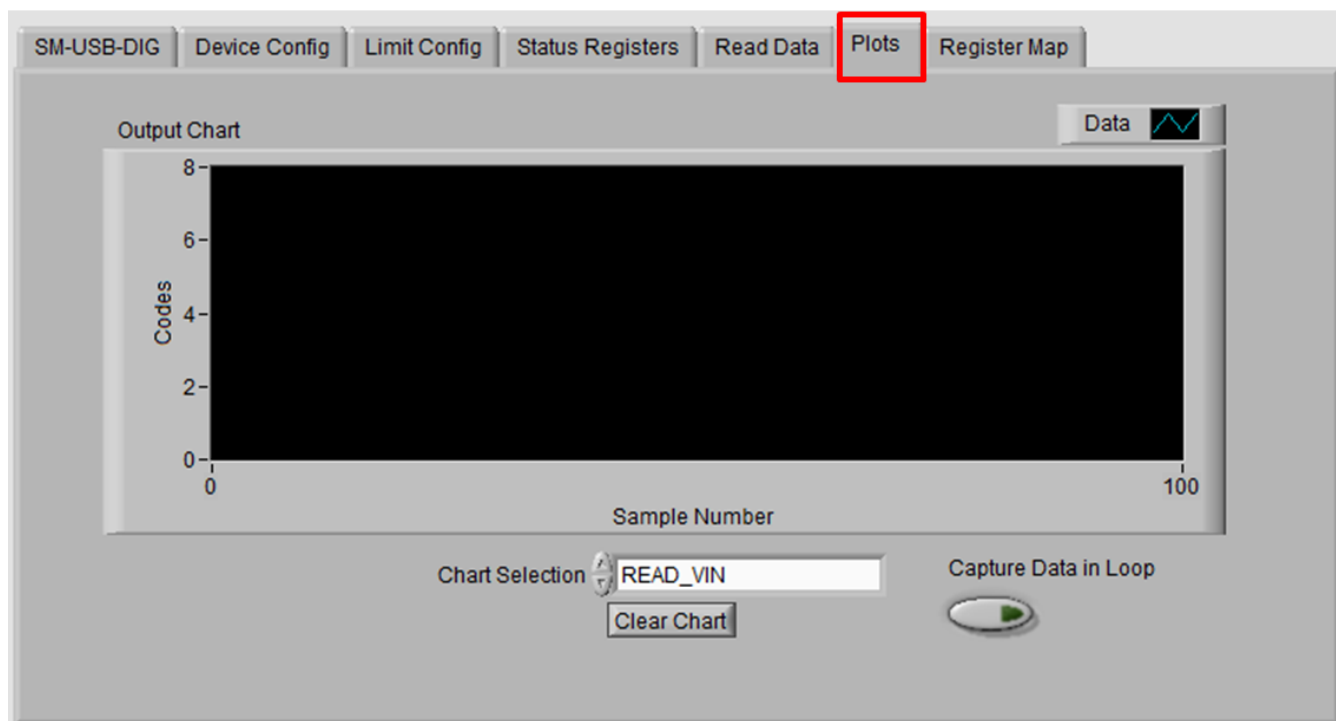


Figure 26. Graphing the INA233 Data

5 INA233EVM Documentation

This section contains the complete bill of materials, schematic diagram, and PCB layout for the INA233EVM.

NOTE: The board layout is not to scale. This image is intended to show how the board is laid out; it is not intended to be used for manufacturing INA233EVM PCBs.

5.1 Schematic

Figure 27 shows the schematic for the INA233EVM.

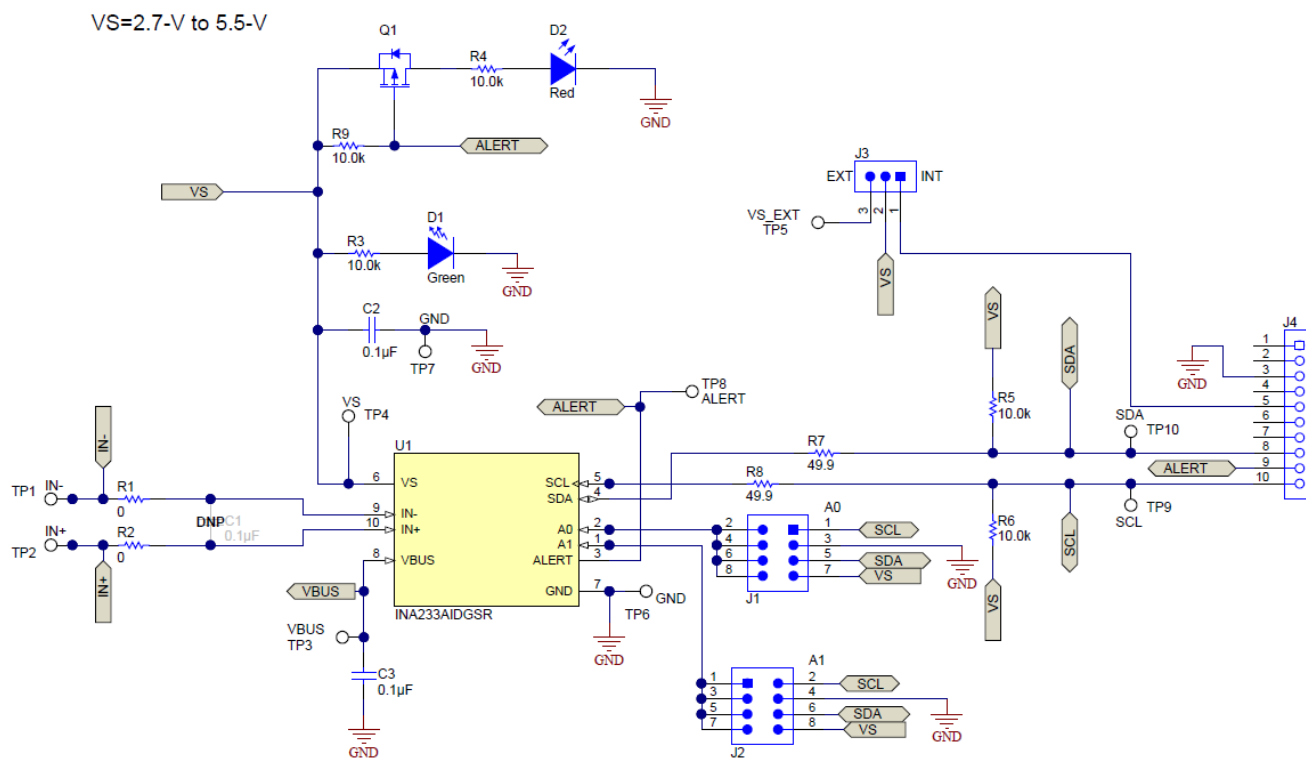


Figure 27. INA233EVM Schematic

5.2 PCB Layout

Figure 28 through Figure 31 illustrate the PCB layout for the INA233EVM.

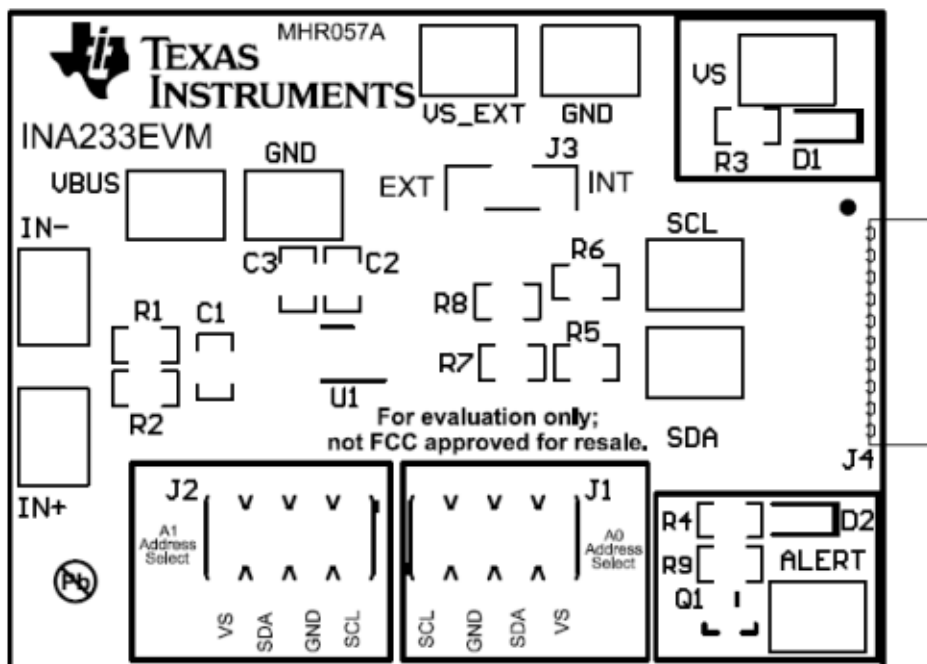


Figure 28. INA233EVM PCB Top Overlay

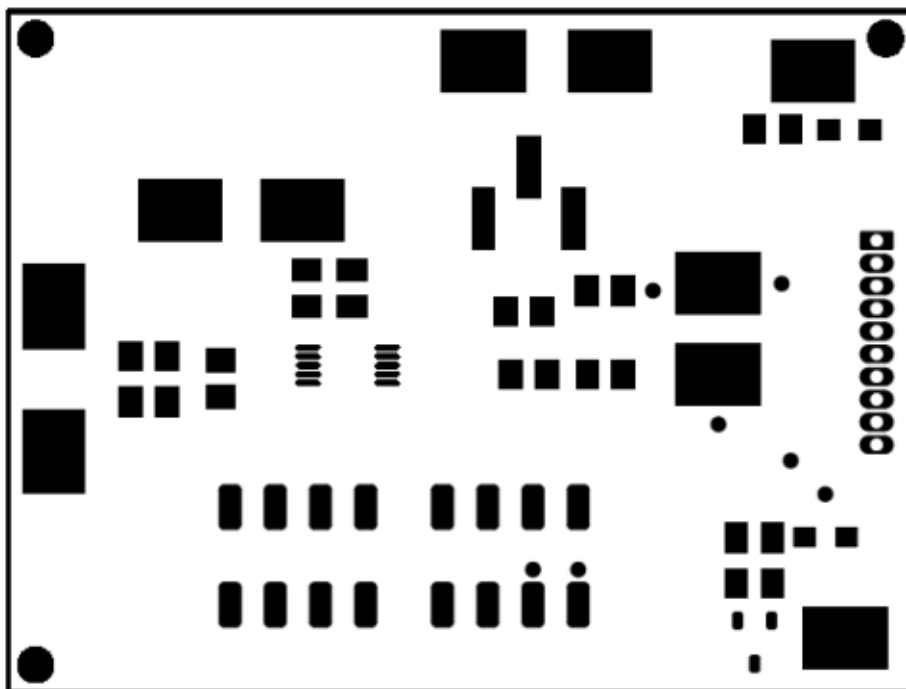


Figure 29. INA233EVM PCB Top Solder

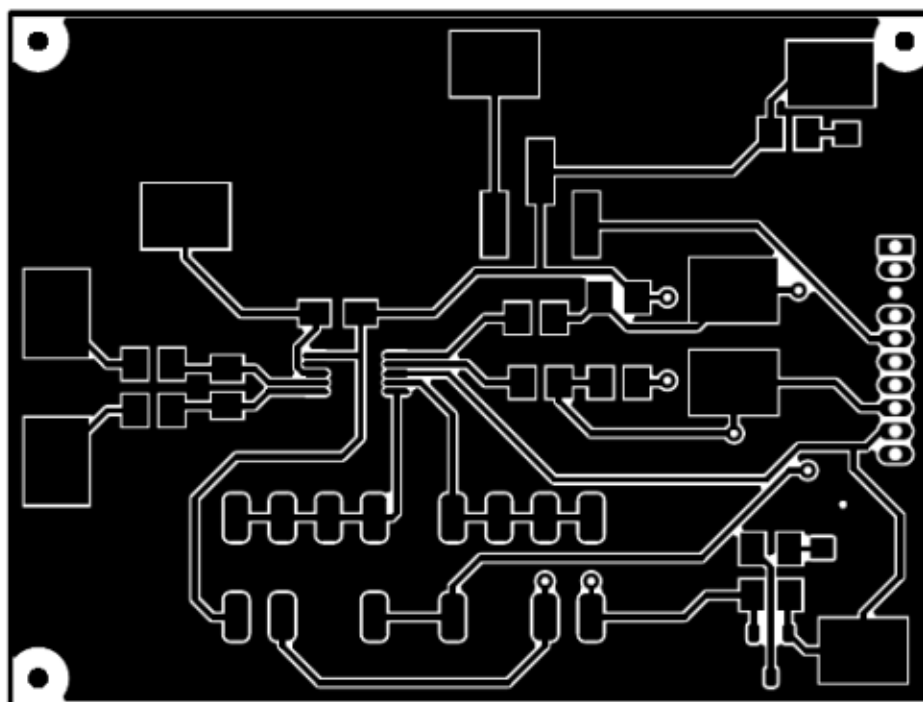


Figure 30. INA233EVM PCB Top Layer

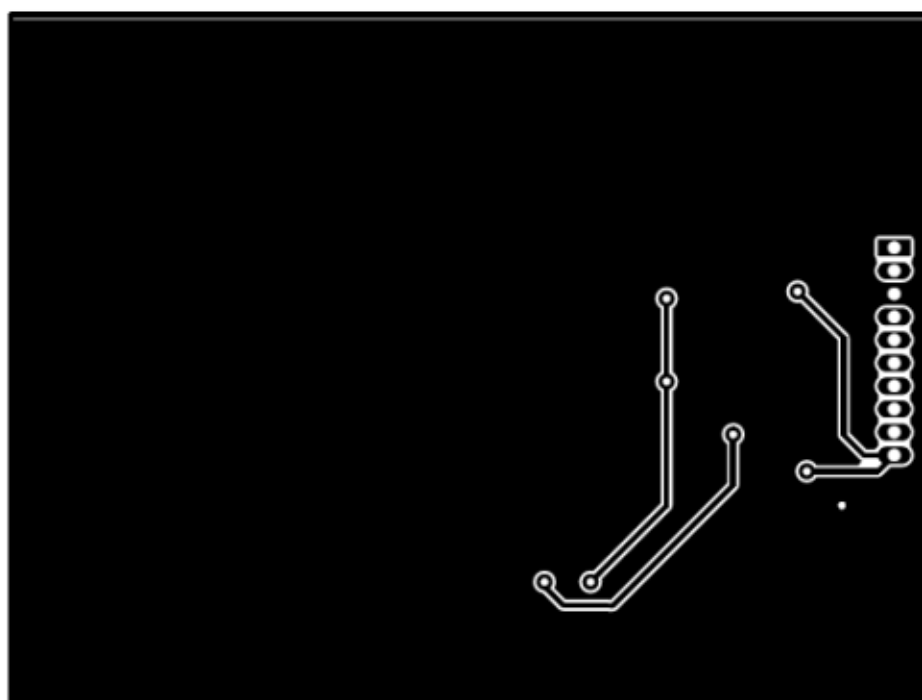


Figure 31. INA233EVM PCB Bottom Layer

5.3 Bill of Materials

Table 6 lists the bill of materials for the INA233EVM.

Table 6. Bill of Materials: INA233EVM

DESIGNATOR	QUANTITY	VALUE	DESCRIPTION	PACKAGE REFERENCE	PART NUMBER	MANUFACTURER
!PCB	1		Printed Circuit Board		MHR057	Any
C2, C3	2	0.1 μ F	CAP, CERM, 0.1 μ F, 50 V, $\pm$ 5%, X7R, 0805	0805	08055C104JAT2A	AVX
D1	1	Green	LED, Green, SMD	LED_0805	APT2012LZGCK	Kingbright
D2	1	Red	LED, Red, SMD	SMD, 2-Leads, Body 2 $\times$ 1.25mm	APT2012LSECK/J3-PRV	Kingbright
H9, H10, H11, H12	4		Bumpon, Hemisphere, 0.44 $\times$ 0.20, Clear	Transparent Bumpon	SJ-5303 (CLEAR)	3M
J1, J2	2		Header, 2.54mm, 4 $\times$ 2, Gold, SMT	Header, 2.54mm, 4 $\times$ 2, SMT	95278-801A08LF	FCI
J3	1		Header, 100mil, 3 $\times$ 1, Gold, SMT	Samtec_TSM-103-01-X-SV	TSM-103-01-L-SV	Samtec
J4	1		Receptacle, 50mil, 10 $\times$ 1, Gold, R/A, TH	receptacle 10 $\times$ 1, 50mil	851-43-010-20-001000	Mill-Max
Q1	1	–50 V	MOSFET, P-CH, –50 V, –0.13 A, SOT-23	SOT-23	BSS84-7-F	Diodes Inc.
R1, R2	2	0	RES, 0, 5%, 0.125 W, 0805	0805	CRCW08050000Z0EA	Vishay-Dale
R3, R4, R5, R6, R9	5	10.0 k	RES, 10.0 k, 1%, 0.125 W, 0805	0805	CRCW080510K0FKEA	Vishay-Dale
R7, R8	2	49.9	RES, 49.9, 1%, 0.125 W, 0805	0805	CRCW080549R9FKEA	Vishay-Dale
SH-J1, SH-J2, SH-J3	3	1 $\times$ 2	Shunt, 100mil, Flash Gold, Black	Closed Top 100mil Shunt	SPC02SYAN	Sullins Connector Solutions
TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP8, TP9, TP10	10		Test Point, Compact, SMT	Testpoint_Keystone_Compact	5016	Keystone
U1	1		High-Side or Low-Side Measurement, Bi-Directional Current and Power Monitor with PMBus Compatible Interface, DGS0010A (10-pin VSSOP)	DGS0010A	INA233AIDGSR	Texas Instruments

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